

## Features

- Epitaxial Planar Die Construction
- Built-In Biasing Resistors
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free "Green" Device (Note 3)**
- **The ADA114YUQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.**

<https://www.diodes.com/quality/product-definitions/>

## Mechanical Data

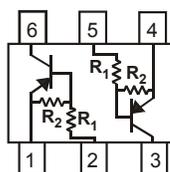
- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 ③
- Weight: 0.006 grams (Approximate)

R <sub>1</sub> (NOM)	R <sub>2</sub> (NOM)
10kΩ	47kΩ

SOT363



Top View



Device Schematic

## Ordering Information (Note 4)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
ADA114YUQ-7	Automotive	1Y6	7	8	3,000
ADA114YUQ-13	Automotive	1Y6	13	8	10,000

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

## Marking Information



1Y6 = Product Type Marking Code  
 YM = Date Code Marking  
 Y or  $\bar{Y}$  = Year (ex: 1 = 2021)  
 M = Month (ex: 9 = September)

### Date Code Key

Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	I	J	K	L	M	N	O	P	R	S	T	U

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

**Absolute Maximum Ratings** (@  $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

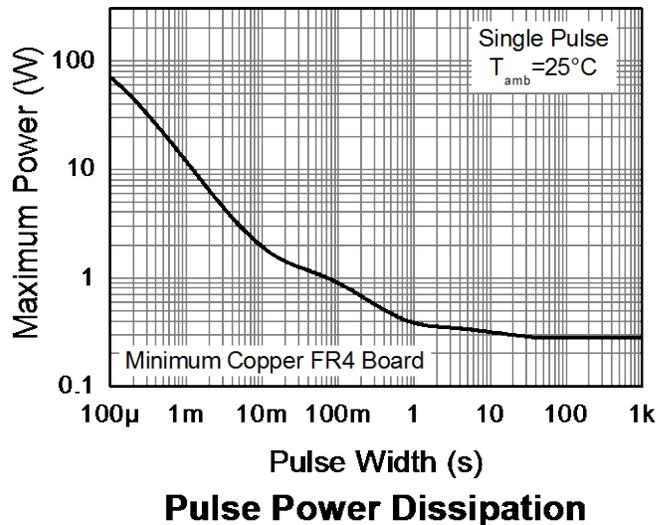
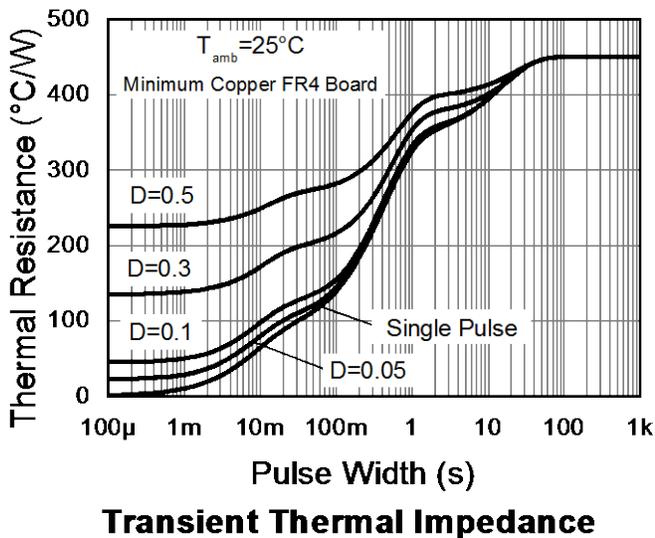
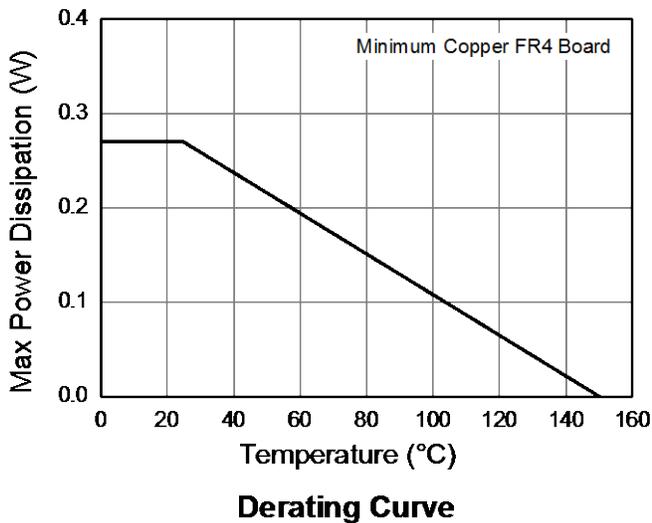
Characteristic	Symbol	Value	Unit
Supply Voltage (1) to (6) and (4) to (3)	$V_{CC}$	-50	V
Input Voltage (1) to (2) and (4) to (5)	$V_{IN}$	+6 to -40	V
Output Current	$I_O$	-70	mA
Output Current	$I_{C(MAX)}$	-100	mA

**Thermal Characteristics** (@  $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Notes 5 & 6)	$P_D$	270	mW
Thermal Resistance, Junction to Ambient Air (Note 5)	$R_{\theta JA}$	450	$^\circ\text{C/W}$
Operating and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150	$^\circ\text{C}$

Notes: 5. Mounted on FR4 PC Board with minimum recommended pad layout.  
6. 150mW per element must not be exceeded.

**Thermal Characteristics and Derating Information**

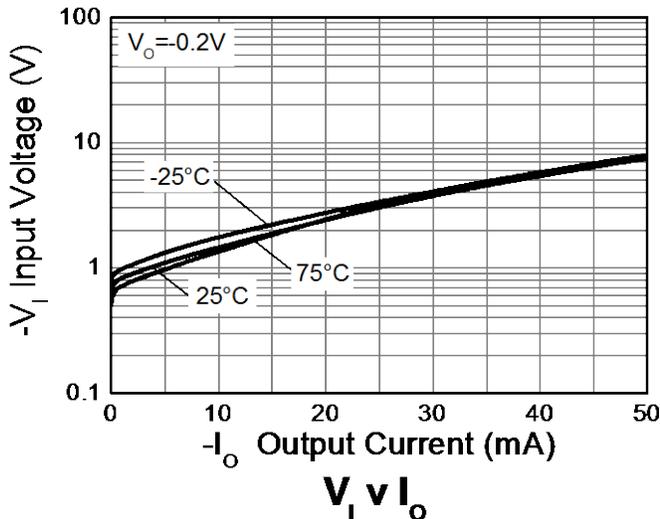
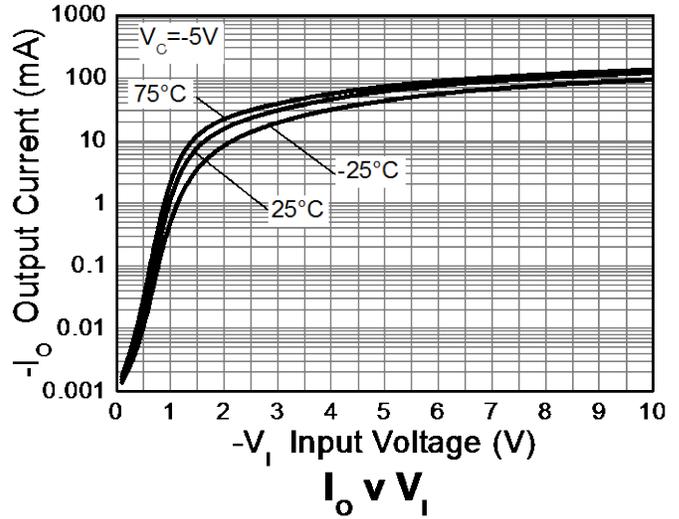
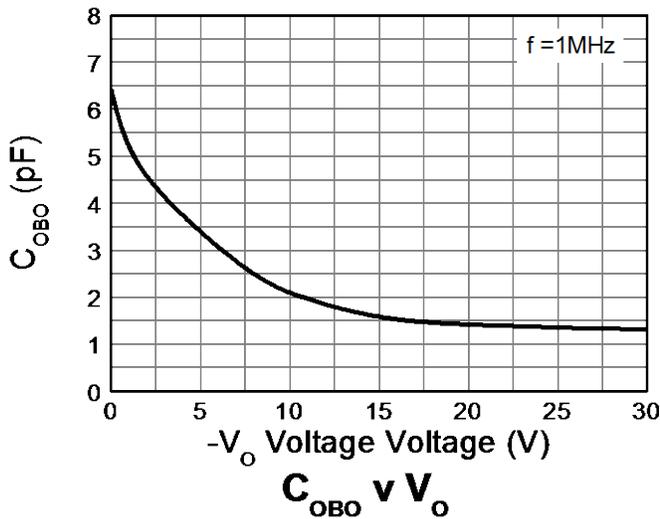
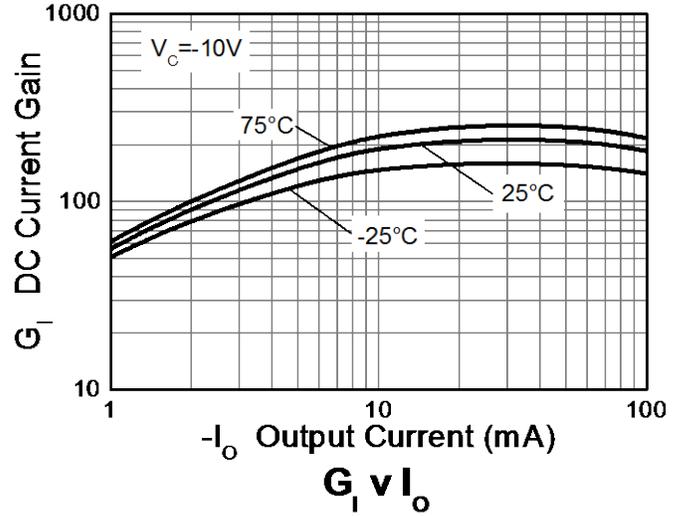
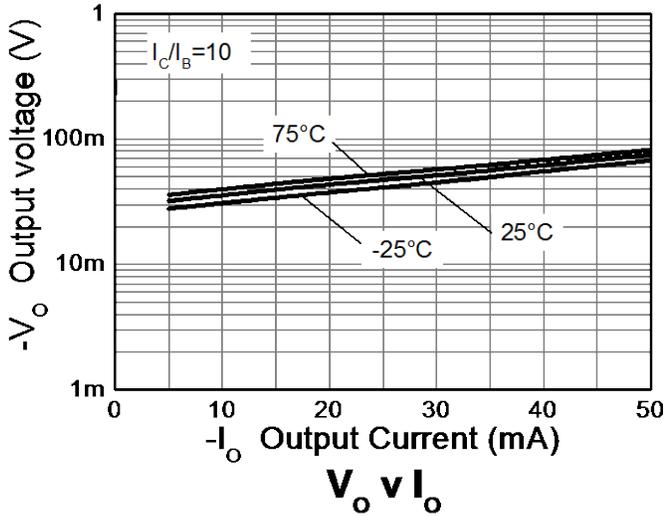


**Electrical Characteristics** (@  $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Input Voltage	$V_{I(\text{off})}$ (Note 7)	-0.3	—	—	V	$V_{CC} = -5\text{V}$ , $I_O = -100\mu\text{A}$
	$V_{I(\text{on})}$ (Note 8)	—	—	-1.4		$V_O = -0.3$ , $I_O = -1\text{mA}$
Output Voltage	$V_{O(\text{on})}$	—	-0.1	-0.3	V	$I_O/I_I = -5\text{mA} / -0.25\text{mA}$
Input Current	$I_I$	—	—	-0.88	mA	$V_I = -5\text{V}$
Output Current	$I_{O(\text{off})}$	—	—	-0.5	$\mu\text{A}$	$V_{CC} = -50\text{V}$ , $V_I = 0\text{V}$
DC Current Gain	$G_I$	68	—	—	—	$V_O = -5\text{V}$ , $I_O = -10\text{mA}$
Input Resistor ( $R_1$ ) Tolerance	$\Delta R_1$	-30	—	+30	%	—
Resistance Ratio Tolerance	$R_2/R_1$	-20	—	+20	%	—
Gain-Bandwidth Product (Note 9)	$f_T$	—	250	—	MHz	$V_{CE} = -10\text{V}$ , $I_E = -5\text{mA}$ , $f = 100\text{MHz}$

Notes: 7. Guarantees that the device will be switched OFF if the Input Voltage is less than -0.3V.  
8. Guarantees that the device will be switched ON if the Input Voltage is more than -1.4V.  
9. Transistor - For Reference Only.

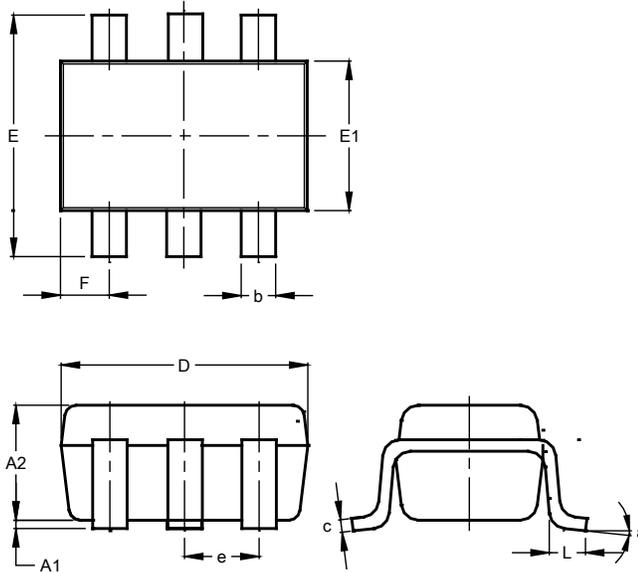
**Typical Electrical Characteristics** (@  $T_A = +25^\circ\text{C}$ , unless otherwise specified.)



**Package Outline Dimensions**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**SOT363**

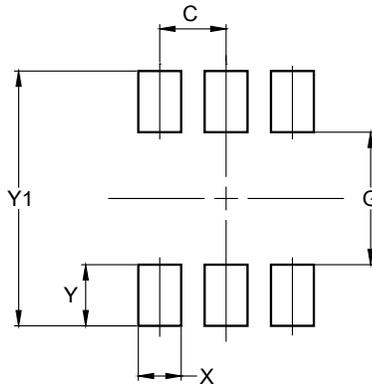


SOT363			
Dim	Min	Max	Typ
A1	0.00	0.10	0.05
A2	0.90	1.00	1.00
b	0.10	0.30	0.25
c	0.10	0.22	0.11
D	1.80	2.20	2.15
E	2.00	2.20	2.10
E1	1.15	1.35	1.30
e	0.650 BSC		
F	0.40	0.45	0.425
L	0.25	0.40	0.30
a	0°	8°	—
All Dimensions in mm			

**Suggested Pad Layout**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**SOT363**



Dimensions	Value (in mm)
C	0.650
G	1.300
X	0.420
Y	0.600
Y1	2.500

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